MRP 7-30-77	
(Hov. 6 93) RE 08-09-11 OMD Ho. 0651 0011 (oxp. 4/94)	999 SHEET U.S. DEPARTMENT OF COMMERCE Palent and Tradomark Office
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To the Honorable Commissioner of F 1011119	
1. Name of conveying party(les): (1)Tetsuya HOSODA	2. Name and address of receiving party(les) Name: FUJITSU LIMITED
Additional name(s) of conveying party(les) attached? U.Yes. & No	Internal Address:
3. Nature of conveyance:	ÿ
Assignment U Merger	Street Address: 1-1, Kamikodanaka 4-chome
U Security Agreement U Change of Name	Nakahara-ku, Kawasaki-shi,
U Other	Clly: Kanaqawa Slate: ZIP: 211-858
Execution Date: July 23, 1999	Country: Japan Additional name(s) & address(os) attached? U Yes & No
4. Application number(s) or patent number(s):	· · · · · · · · · · · · · · · · · · ·
	on, the execution date of the application is: $Ju1y 23$, 1999
A. Patent Application No.(s) 09/364582	B. Patent No.(s)
DOCKET NO.: NECZ 13.362	nitachod? U Yes U No
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: HELFGOTT & KARAS, P.C.	7. Total fee (37 CFB 3.41)\$ 40.00
Internal Address: EMPIRE STATE BUILDING	Lar Enclosed
60 TH FLOOR	U Authorized to be charged to deposit account
Street Address: 350 5TH AVENUE	8. Deposit account number:
SUITE 6024	08-1634
Cliy: NEW YORK State: NY ZIP: 10118	(Attach duplicate copy of this page if paying by deposit account)
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the original document. Aaron B. Karas Name of Person Signing	Signature Signature g coversion, allaciments, and any allached copy is a true copy of 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2
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	Trademarks, Box Assignmen g on, D.C. 20231
Anv fee due with this paper, not fully ad by an enclosed check, may be ed on Deposit Acct. No. 08-1634	Filed by Express Mail (Redein No <u>LISES) ob 2001 3029555</u> Purgunatio 37 555
	PATENT
	REEL 010142 FRAME: 0147

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UNITED STATES

ASSIGNMENT

Docket No. NECZ 16.362

WHEREAS, the below named inventor, ASSIGNOR, has made a certain new and useful invention in : _____

SEMICONDUCTOR LASER DEVICE AND MANUFACTURING METHOD OF THE SAME

IOI WHICH		
(check one)	[X]	an application is being filed concurrently herewith,
	[]	an application for a Patent of the United States was filed on
	[]	and given Application Serial No.
and WHERE	AS,	NEC Corporation
having a plac	ce of bu	siness at <u>7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan</u>
		ASSIGNEE

is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the said ASSIGNOR, has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States application under the same the priority rights derived from said United States application under the same the priority in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitational Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, including, without limitation, patents, utility models, inventor's certificates and designs which may be granted for said invention in any country or countries foreign to the United States application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventor's certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

ASSIGNOR authorizes and requests the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR covenants and agrees that he has full right to convey the entire interest herein assigned, and has not executed, and will not execute, any agreement in conflict herewith.

AND ASSIGNOR further covenants and agrees that he will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

Full name of sole or first inventor Tetsuya HOSOE	DA
Inventor's signature Tetsuya Hosoda	Date 23/7/1999
	Citizenship Japanese
Residence Tokyo, Japan	7-1, Shiba 5-chome, Minato-ku,
Post Unice Address	(-1, Shiba S-chome; Minaco-ku;
Tokyo, Japan	

Witness:

Aitain Ukan

RECORDED: 07/30/1999